MA2S377

Silicon epitaxial planar type

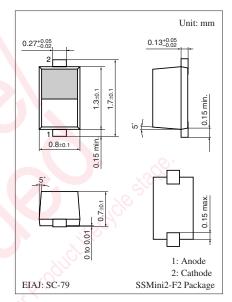
For VCO, VCXO and TCXO

■ Features

• SS-Mini type package, allowing downsizing of equipment and automatic insertion through the taping package

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V_R	12	V	
Forward current	I_{F}	20	mA	
Junction temperature	T _j	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	



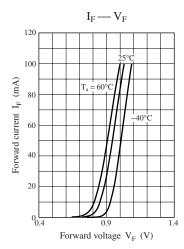
Marking Symbol: 7

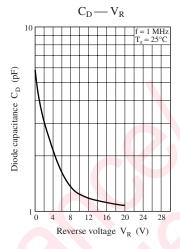
■ Electrical Characteristics $T_a = 25 \pm 3$ °C

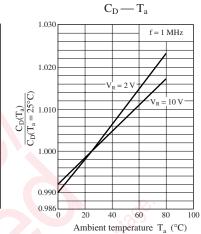
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current	I_R	$V_R = 12 \text{ V}$	100	0	10	nA
Diode capacitance	$C_{D(2V)}$	$V_R = 2 V, f = 1 MHz$	2.80)-	3.40	pF
	C _{D(10V)}	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$	1.10		1.50	
Capacitance ratio	C _{D(2V)} /C _{D(10V)}	618 9. 1100 100	2.20		2.80	_
Series resistance *	r_{D}	$C_D = 9 \text{ pF, f} = 470 \text{ MHz}$		0.40	0.60	Ω

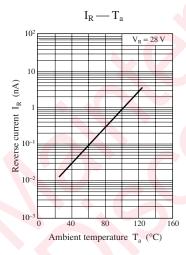
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. Absolute frequency of input and output is 470 MHz.
- 3. *: Measuring instrument; YHP MODEL 4191A RF IMPEDANCE ANALYZER









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